

3 A Schottky Barrier Rectifier

DESCRIPTION

This UPS360e3 in the Powermite3® package is a high efficiency Schottky rectifier that is also RoHS compliant offering high current/power capabilities previously found only in much larger packages. They are ideal for SMD applications that operate at high frequencies. In addition to its size advantages, the Powermite3® package includes a full metallic bottom that eliminates the possibility of solder flux entrapment during assembly and a unique locking tab act as an efficient heat path to the heat-sink mounting. Its innovative design makes this device ideal for use with automatic insertion equipment.

KEY FEATURES

- Very low thermal resistance package
- RoHS Compliant with e3 suffix part number
- Guard-ring-die construction for transient protection
- Efficient heat path with Integral locking bottom metal tab
- Low forward voltage
- Full metallic bottom eliminates flux entrapment
- Compatible with automatic insertion
- Low profile-maximum height of 1mm

IMPORTANT: For the most current data, consult MICROSEMI's website: http://www.microsemi.com

ABSOLUTE MAXIMUM RATINGS AT 25° C (UNLESS OTHERWISE SPECIFIED)

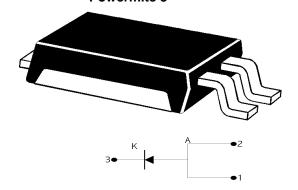
Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$egin{array}{c} egin{array}{c} egin{array}{c} V_{RMM} \ egin{array}{c} V_R \end{array}$	60	V
RMS Reverse Voltage	V _{R (RMS)}	42	V
Average Rectified Output Current	Io	3	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine wave Superimposed on Rated Load	I _{FSM}	100 @ 25°C 50 @ 100°C	А
Storage Temperature	T_{STG}	-55 to +150	°C
Junction Temperature	TJ	-55 to +125	°C

THERMAL CHARACTERISTICS

Thermal Resistance			
Junction-to-case (bottom)	R _{eJC}	3.2	°C/ Watt
Junction to ambient (1)	Rou	65	°C/ Watt

(1) When mounted on FR-4 PC board using 2 oz copper with recommended minimum foot print

Powermite 3™



APPLICATIONS/BENEFITS

- Switching and Regulating Power Supplies.
- Silicon Schottky (hot carrier) rectifier for minimal reverse voltage recovery
- Elimination of reverse-recovery oscillations to reduce need for EMI filtering
- Charge Pump Circuits
- Reduces reverse recovery loss with low I_{RM}
- Small foot print 190 X 270 mils (1:1 Actual size)
 See mounting pad details on pg 3

MECHANICAL & PACKAGING

- CASE: Void-free transfer molded thermosetting epoxy compound meeting UL94V-0
- FINISH: Annealed matte-Tin plating over copper and readily solderable per MIL-STD-750 method 2026 (consult factory for Tin-Lead plating)
- POLARITY: See figure (left)
- MARKING: S360•
- WEIGHT: 0.072 gram (approx.)
- Package dimension on last page
- Tape & Reel option: 16 mm tape per Standard EIA-481-B, 5000 on 13" reel

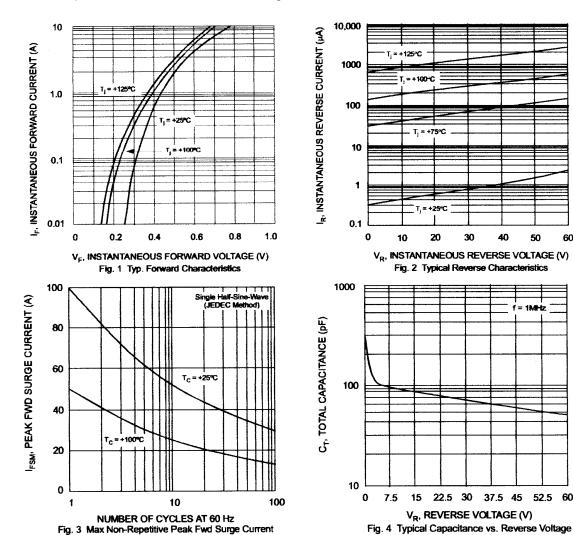
Copyright © 2007 10-15-07 Rev C



3 A Schottky Barrier Rectifier

ELECTRICAL PARAMETERS @ 25°C (unless otherwise specified)						
Parameter	Symbol	Conditions	Min	Тур.	Max	Units
Forward Voltage (Note 1)	V _F	$I_F = 3.5 \text{ A}, T_j = 25 ^{\circ}\text{C}$ $I_F = 3.5 \text{ A}, T_j = 125 ^{\circ}\text{C}$ $I_F = 7 \text{ A}, T_j = 25 ^{\circ}\text{C}$ $I_F = 7 \text{ A}, T_j = 25 ^{\circ}\text{C}$		0.59 0.53 0.72 0.63	0.63 0.57 0.76 0.67	V
Reverse Break Down Voltage (Note 1)	V_{BR}	I _R = 0.2 mA	60			V
Reverse Current (Note 1)	I _R	V _R = 60V, T _j = 25 °C V _R = 60V, T _j =100 °C V _R = 60V, T _j =125 °C		2 0.6 2.5	200 20 150	μA mA mA
Capacitance	Ст	V _R = 4 V; f = 1 MH _Z		130		pF

Note: 1 Short duration test pulse used to minimize self-heating effect.

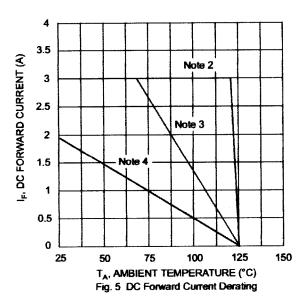


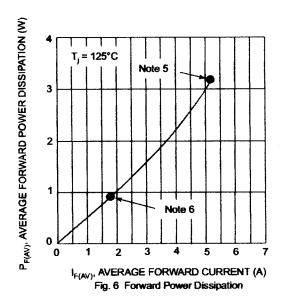
60

50



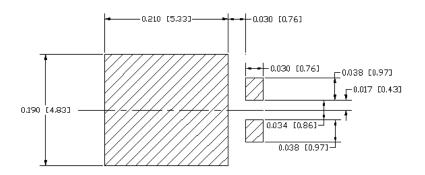
3 A Schottky Barrier Rectifier





- Notes: 2. $T_A = T_{SOLDERING\ POINT,}\ R_{\Theta JS} = 3.2^{\circ}\ C/W$ $R_{\Theta SA} = 0^{\circ}\ C/W.$ 3. Device mounted on GETEK substrate, 2" x 2", 2 oz. copper , double-sided , cathode pad dimensions 0.75" x 1.0", anode pad dimensions 0.25" x 1.0". R_{O,JA} in range of 20-40° C/W.
 - 4. Device mounted on FRA-4 substrate, 2" x 2", 2 oz. copper, single-sided, pad layout R_{OJA} in range of 65° C/W. See mounting pad below.
 - 5. Maximum power dissipation when the device is mounted in accordance to the conditions described in Note 3.

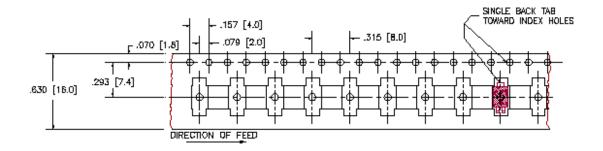
PAD LAYOUT inches [mm]



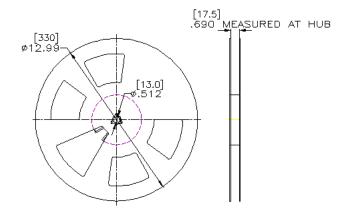


3 A Schottky Barrier Rectifier

16 mm TAPE



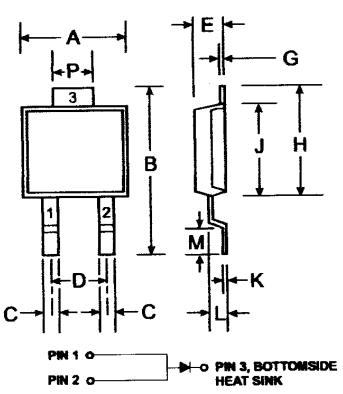
13 INCH REEL





3 A Schottky Barrier Rectifier

PACKAGE & MOUNTING PAD DIMENSIONS



POWERMITE®3			
Dim	Min	Max	
A	4.03	4.09	
В	6.40	6.61	
С	.889 NOM		
Ð	1.83 NOM		
Ε	1.10	1.14	
G	.178 NOM		
Н	5.01	5.17	
J	4.37	4.43	
K	.178 NOM		
L	.71	.77	
M	.36	.46	
P	1.73	1.83	
All Dimensions in mm			

Note:

Pins 1 & 2 must be electrically connected at the printed circuit board.